查询2SK1163供应商

2SK1163, 2SK1164

Silicon N-Channel MOS FET

HITACHI

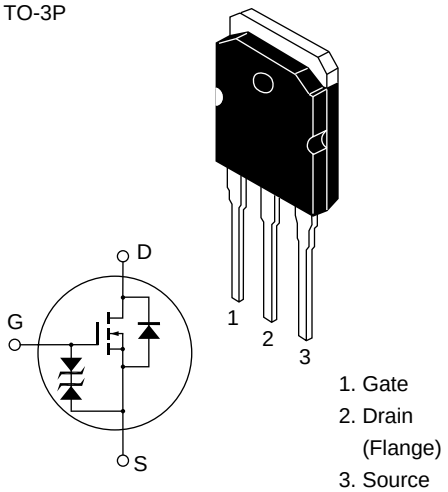
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



1. Gate
2. Drain (Flange)
3. Source

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Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1163	V_{DSS}	450	V
	2SK1164		500	
Gate to source voltage		V_{GSS}	±30	V
Drain current		I_D	11	A
Drain peak current		$I_{D(pulse)}$*[1]	40	A
Body to drain diode reverse drain current		I_{DR}	11	A
Channel dissipation		Pch*[2]	100	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	–55 to +150	°C

Notes: 1. PW ≤ 10 μs, duty cycle ≤ 1%
2. Value at T_C = 25°C

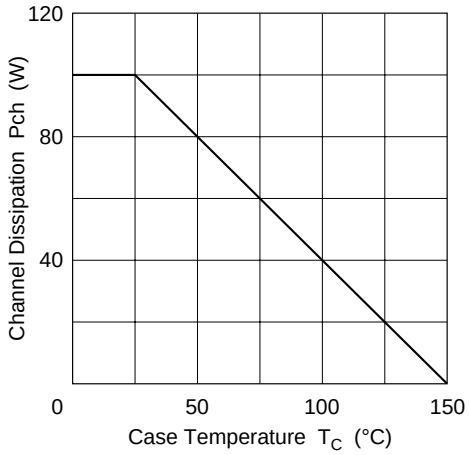
Electrical Characteristics (Ta = 25°C)

Item		Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	2SK1163	$V_{(BR)DSS}$	450	—	—	V	I_D = 10 mA, V_{GS} = 0
	2SK1164		500				
Gate to source breakdown voltage		$V_{(BR)GSS}$	±30	—	—	V	I_G = ±100 µA, V_{DS} = 0
Gate to source leak current		I_{GSS}	—	—	±10	µA	V_{GS} = ±25 V, V_{DS} = 0
Zero gate voltage drain current	2SK1163	I_{DSS}	—	—	250	µA	V_{DS} = 360 V, V_{GS} = 0
	2SK1164						V_{DS} = 400 V, V_{GS} = 0
Gate to source cutoff voltage		$V_{GS(off)}$	2.0	—	3.0	V	I_D = 1 mA, V_{DS} = 10 V
Static Drain to source on state resistance	2SK1163	$R_{DS(on)}$	—	0.55	0.7	Ω	I_D = 5 A, V_{GS} = 10 V *[1]
	2SK1164		—	0.60	0.8		
Forward transfer admittance		|yfs|	5.0	8.0	—	S	I_D = 5 A, V_{DS} = 10 V *[1]
Input capacitance		Ciss	—	1150	—	pF	V_{DS} = 10 V, V_{GS} = 0, f = 1 MHz
Output capacitance		Coss	—	340	—	pF	
Reverse transfer capacitance		Crss	—	55	—	pF	
Turn-on delay time		$t_{d(on)}$	—	17	—	ns	I_D = 5 A, V_{GS} = 10 V, R_L = 6 Ω
Rise time		t_r	—	60	—	ns	
Turn-off delay time		$t_{d(off)}$	—	95	—	ns	
Fall time		t_f	—	50	—	ns	
Body to drain diode forward voltage		V_{DF}	—	1.0	—	V	I_F = 11 A, V_{GS} = 0
Body to drain diode reverse recovery time		t_{rr}	—	400	—	ns	I_F = 11 A, V_{GS} = 0, di_F/dt = 100 A/µs

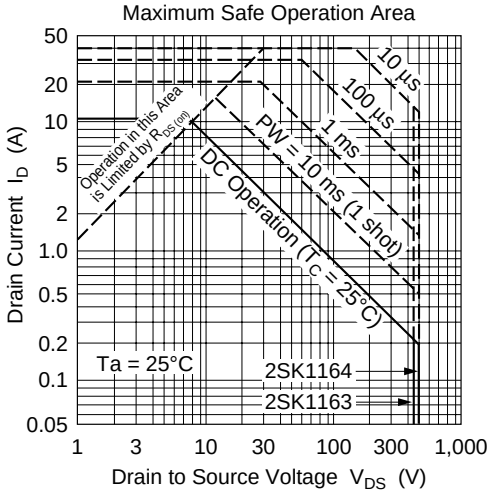
Note: 1. Pulse test

See characteristic curves of 2SK1159, 2SK1160.

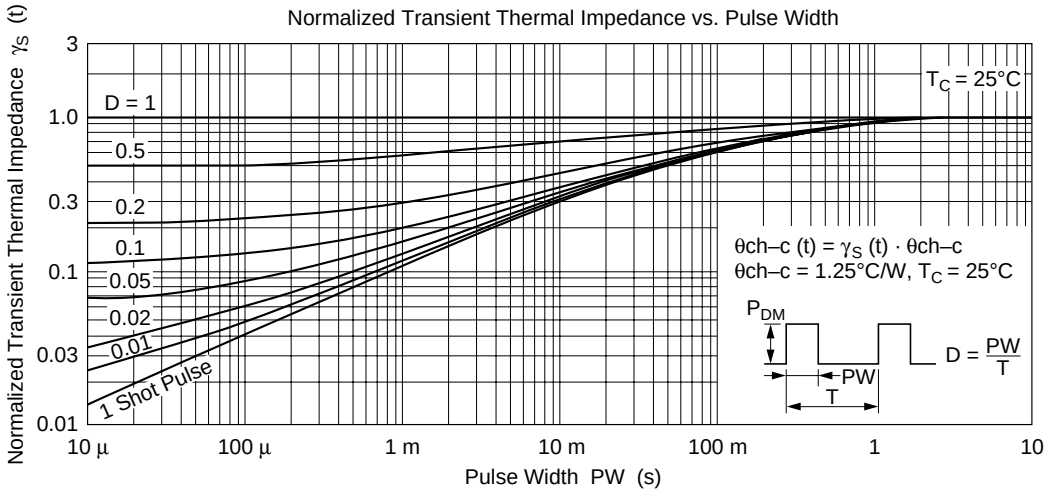
Power vs. Temperature Derating



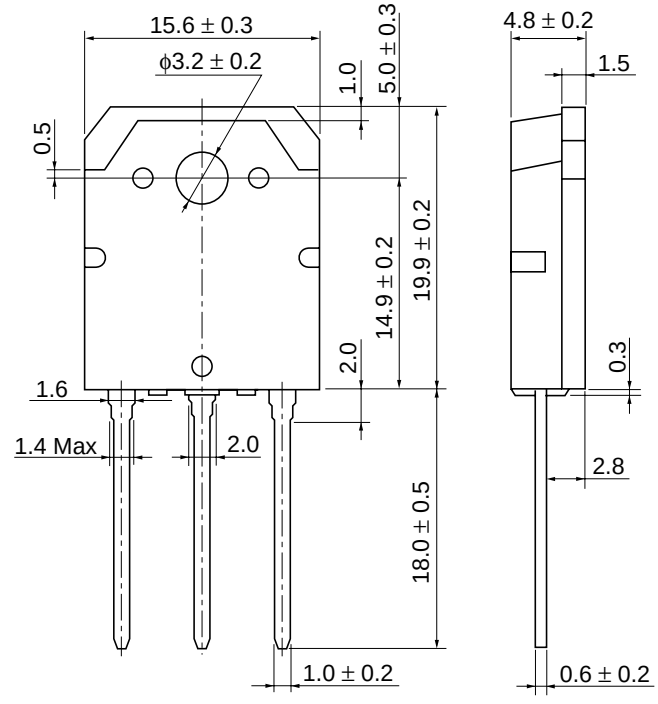
Maximum Safe Operation Area

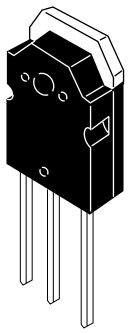


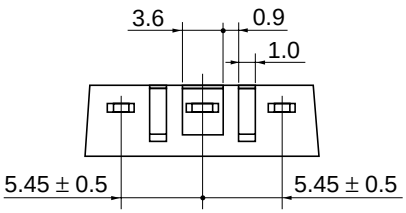
Normalized Transient Thermal Impedance vs. Pulse Width



Unit: mm







Hitachi Code	TO-3P
JEDEC	—
EIAJ	Conforms
Weight (reference value)	5.0 g

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